# UNISONIC TECHNOLOGIES CO., LTD

6N65K Power MOSFET

# 6A, 650V **N-CHANNEL POWER MOSFET**

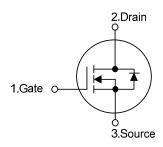
#### DESCRIPTION

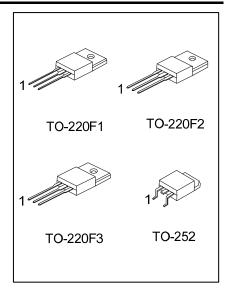
The UTC 6N65K is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

### **FEATURES**

- \*  $R_{DS(ON)}$  < 1.7 $\Omega$  @ $V_{GS}$  = 10V
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

#### **SYMBOL**

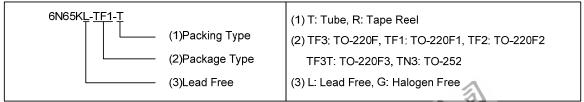




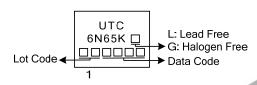
#### ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
6N65KL-TF1-T	6N65KG-TF1-T	TO-220F1	G	D	S	Tube	
6N65KL-TF2-T	6N65KG-TF2-T	TO-220F2	G	D	S	Tube	
6N65KL-TF3T-T	6N65KG-TF3T-T	TO-220F3	G	D	S	Tube	
6N65KL-TN3-R	6N65KG-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### **MARKING**



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## ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	650	V
Gate-Source Voltage		$V_{GSS}$	±30	V
Avalanche Current (Note 2)		$I_{AR}$	6	Α
Continuous Drain Current		$I_{D}$	6	Α
Pulsed Drain Current (Note 2)		$I_{DM}$	24	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	300	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	ns
Power Dissipation	TO-220F1/TO-220F3		40	W
	TO-220F2	$P_{D}$	42	W
	TO-252		55	W
Junction Temperature		$T_J$	+150	°C
Operating Temperature		$T_{OPR}$	-55 ~ +150	°C
Storage Temperature		$T_{STG}$	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by T<sub>J</sub>
- 3. L = 16.6mH,  $I_{AS}$  = 6A,  $V_{DD}$  = 90V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le 6A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

## **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient	TO-220F1/TO-220F2 TO-220F3	$\theta_{JA}$	62.5	°C/W	
	TO-252		110		
Junction to Case	TO-220F1/TO-220F3		3.2	°C/W	
	TO-220F2	$\theta_{JC}$	2.97		
	TO-252		2.27		



## ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

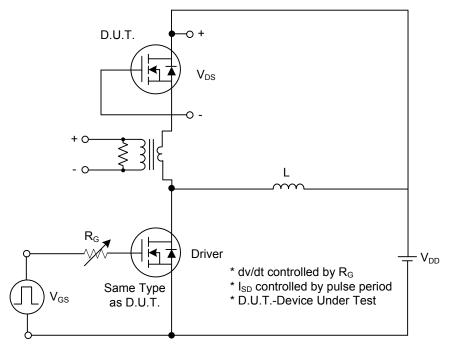
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250\mu A$	650			V		
Drain-Source Leakage Current	I <sub>DSS</sub>	$V_{DS} = 650V, V_{GS} = 0V$			10	μΑ		
Cata Source Lookage Current Forward	1000	$V_{GS} = 30V, V_{DS} = 0V$			100	nA		
Gate- Source Leakage Current Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA		
Breakdown Voltage Temperature Coefficient	$\triangle BV_{DSS}/\triangle T_{J}$	I <sub>D</sub> =250μA, Referenced to 25°C		0.53		V/°C		
ON CHARACTERISTICS								
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 3A$		1.1	1.7	Ω		
DYNAMIC CHARACTERISTICS								
Input Capacitance	C <sub>ISS</sub>	-V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, -f=1.0 MHz		875	1000	pF		
Output Capacitance	Coss			88	120	pF		
Reverse Transfer Capacitance	C <sub>RSS</sub>			8	25	pF		
SWITCHING CHARACTERISTICS								
Turn-On Delay Time	t <sub>D(ON)</sub>			50	60	ns		
Turn-On Rise Time	t <sub>R</sub>	$V_{DD}$ =30V, $I_{D}$ =0.5A,		65	80	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	$R_G = 25\Omega$ (Note 1, 2)		110	130	ns		
Turn-Off Fall Time	t <sub>F</sub>			55	70	ns		
Total Gate Charge	$Q_G$	V -50V I -4.2A		22.5	40	nC		
Gate-Source Charge	$Q_GS$	V <sub>DS</sub> =50V, I <sub>D</sub> =1.3A, -V <sub>GS</sub> =10V (Note 1, 2)		7.5		nC		
Gate-Drain Charge	$Q_GD$	VGS-10V (Note 1, 2)		5		nC		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0 \text{ V}, I_{S} = 6 \text{ A}$			1.4	V		
Maximum Continuous Drain-Source Diode	l <sub>a</sub>				6	A		
Forward Current	I <sub>S</sub>				U	^		
Maximum Pulsed Drain-Source Diode	I <sub>SM</sub>				24	Α		
Forward Current	ISIVI				<b>4</b> -7	, · ·		

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

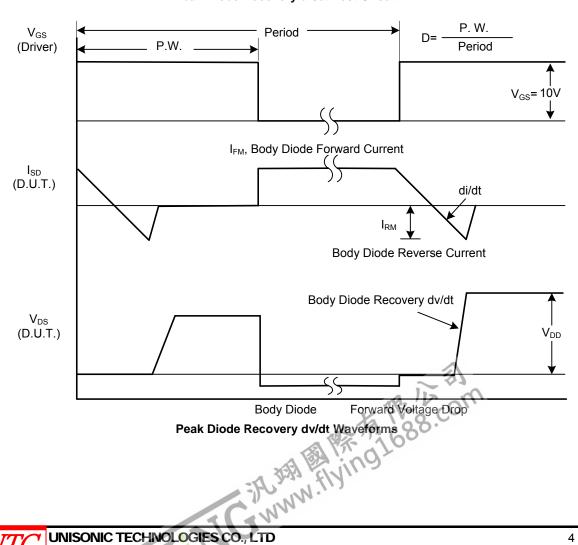
2. Essentially independent of operating temperature



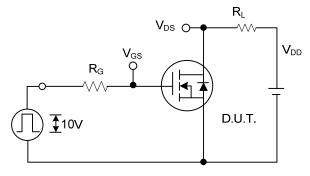
## **TEST CIRCUITS AND WAVEFORMS**



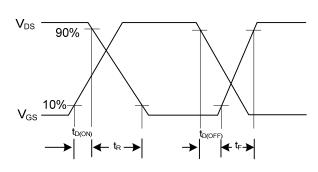
Peak Diode Recovery dv/dt Test Circuit



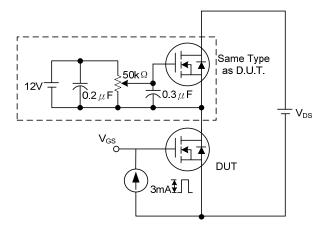
## ■ TEST CIRCUITS AND WAVEFORMS (Cont.)



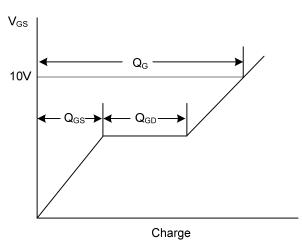
**Switching Test Circuit** 



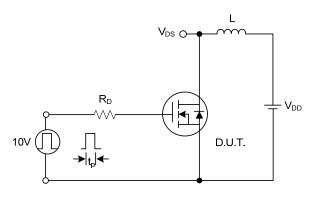
**Switching Waveforms** 



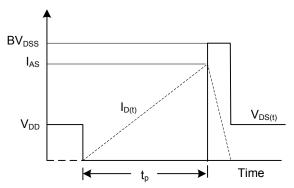
**Gate Charge Test Circuit** 



**Gate Charge Waveform** 

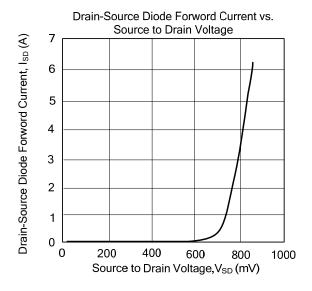


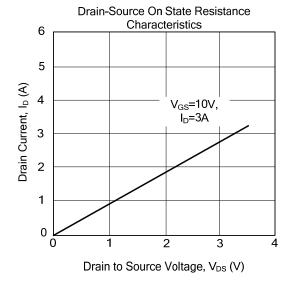
**Unclamped Inductive Switching Test Circuit** 

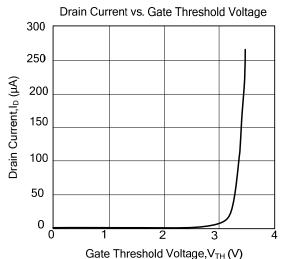


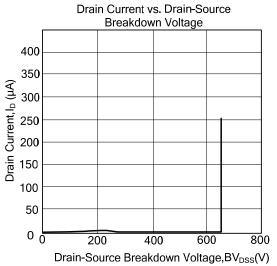
**Unclamped Inductive Switching Waveforms** 

## **■ TYPICAL CHARACTERISTICS**









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